





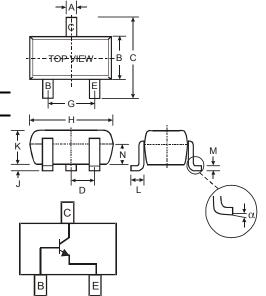
NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- **Epitaxial Planar Die Construction**
- Complementary PNP Type Available (MMBT2907AT)
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking Information: 1P, See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.002 grams (approximate)



SOT-523										
Dim	Min	Max	Тур							
Α	0.15	0.30	0.22							
В	0.75	0.85	0.80							
С	1.45	1.75	1.60							
D		_	0.50							
G	0.90	1.10	1.00							
Н	1.50	1.70	1.60							
J	0.00	0.10	0.05							
K	0.60	0.80	0.75							
L	0.10	0.30	0.22							
М	0.10	0.20	0.12							
N	0.45	0.65	0.50							
α	0°	8°								
All Dimensions in mm										

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Collector-Base Voltage		V _{CBO}	75	V
Collector-Emitter Voltage		V _{CEO}	40	V
Emitter-Base Voltage		V_{EBO}	6.0	V
Collector Current - Continuous		Ic	600	mA
Power Dissipation	(Note 1)	P _d	150	mW
Thermal Resistance, Junction to Ambient	(Note 1)	$R_{ heta JA}$	833	°C/W
Operating and Storage Temperature Range		T _j , T _{STG}	-55 to +150	°C

Notes:

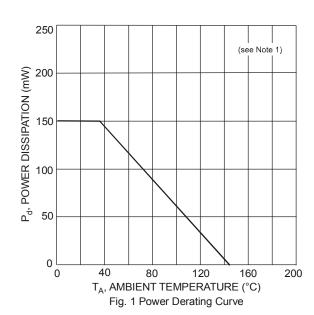
- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- No purposefully added lead
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

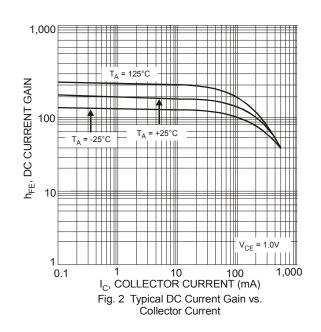


Electrical Characteristics @TA = 25°C unless otherwise specified

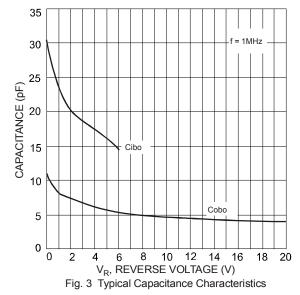
Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)					
Collector-Base Breakdown Voltage	V _{(BR)CBO}	75	_	V	$I_C = 10\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	40	_	V	$I_C = 10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	6.0	_	V	$I_E = 10\mu A, I_C = 0$
Collector Cutoff Current	I _{CEX}	_	10	nA	V _{CE} = 60V, V _{EB(OFF)} = 3.0V
Base Cutoff Current	I _{BL}	_	20	nA	V _{CE} = 60V, V _{EB(OFF)} = 3.0V
ON CHARACTERISTICS (Note 5)					
DC Current Gain	h _{FE}	35 50 75 100 40		_	$I_C = 100\mu A, V_{CE} = 10V$ $I_C = 1.0mA, V_{CE} = 10V$ $I_C = 10mA, V_{CE} = 10V$ $I_C = 150mA, V_{CE} = 10V$ $I_C = 500mA, V_{CE} = 10V$
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	0.3 1.0	V	I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	0.6	1.2 2.0	V	$I_C = 150$ mA, $I_B = 15$ mA $I_C = 500$ mA, $I_B = 50$ mA
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C_{obo}	_	8	pF	$V_{CB} = 10V$, $f = 1.0MHz$, $I_E = 0$
Input Capacitance	C _{ibo}	_	30	pF	$V_{EB} = 0.5V$, $f = 1.0MHz$, $I_C = 0$
Current Gain-Bandwidth Product	f _T	300	_	MHz	$V_{CE} = 20V, I_{C} = 20mA,$ f = 100MHz
Input Impedance	h _{ie}	0.25	1.25	kΩ	V_{CE} = 10 Vdc, I_{C} = 10 mAdc, f = 1.0kHz
Voltage Feedback Ratio	h _{re}	_	4.0	X 10 ⁻⁴	V_{CE} = 10 Vdc, I_{C} = 10 mAdc, f = 1.0kHz
Small-Signal Current Gain	h _{fe}	75	375	_	V_{CE} = 10 Vdc, I_{C} = 10 mAdc, f = 1.0kHz
Output Admittance	h _{oe}	25	200	μS	V_{CE} = 10 Vdc, I_{C} = 10 mAdc, f = 1.0kHz
SWITCHING CHARACTERISTICS					
Delay Time	t _d		10	ns	V _{CC} = 30V, I _C = 150mA,
Rise Time	t _r	_	25	ns	$V_{BE(off)} = -0.5V, I_{B1} = 15mA$
Storage Time	t _s		225	ns	V _{CC} = 30V, I _C = 150mA,
Fall Time	t _f	_	60	ns	$I_{B1} = I_{B2} = 15mA$

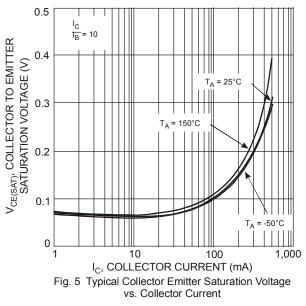
Notes: 5. Short duration pulse test used to minimize self-heating effect.

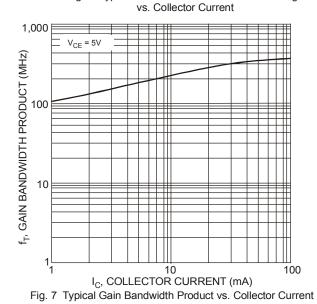


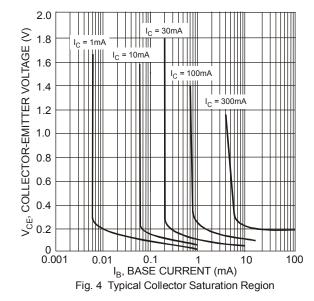


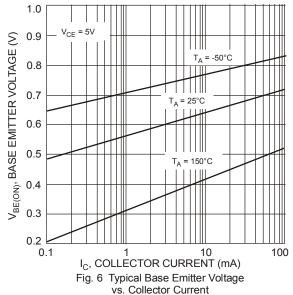












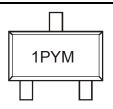


Ordering Information (Note 6)

Device	Packaging	Shipping				
MMBT2222AT-7-F	SOT-523	3000/Tape & Reel				

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



1P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Kev

Date Code Rey															
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	Κ	L	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Fe	b	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	:t	Nov	Dec
Code	1	2		3	4	5	6	;	7	8	9	0		N	D

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